

1200V, 25A, $V_{_{ce(on)}}\,$ = 2.5V Typical

Ultra Fast NPT - IGBT®

The Ultra Fast NPT - IGBT[®] family of products is the newest generation of planar IGBTs optimized for outstanding ruggedness and the best trade-off between conduction and switching losses.

Features

- Low Saturation Voltage
- Low Tail Current
- RoHS Compliant *M*

- Short Circuit Withstand Rated
- High Frequency Switching
- Ultra Low Leakage Current

Unless stated otherwise, Microsemi discrete IGBTs contain a single IGBT die. This device is recommended for applications such as induction heating (IH), motor control, general purpose inverters and uninterruptible power supplies (UPS).

MAXIMUM RATINGS

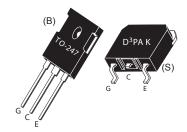
All Ratings: $T_c = 25^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Ratings	Unit	
V _{ces}	Collector Emitter Voltage	1200	V	
V_{GE}	Gate-Emitter Voltage	±30	V	
I _{C1}	Continuous Collector Current @ T_c = 25°C	75		
I _{C2}	Continuous Collector Current @ T _c = 125°C	25	А	
I _{CM}	Pulsed Collector Current ①	100		
SCWT	Short Circuit Withstand Time: V_{ce} = 600V, V_{ge} = 15V, T_c = 125°C	10	μs	
P _D	Total Power Dissipation @ $T_c = 25^{\circ}C$	521	W	
T_,T _{stg}	Operating and Storage Junction Temperature Range	-55 to 150		
TL	Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec.	300	°C	

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Min	Тур	Max	Unit
V _{(BR)CES}	Collector-Emitter Breakdown Voltage ($V_{GE} = 0V$, $I_{C} = 500\mu$ A)	1200			
V _{GE(TH)}	Gate Threshold Voltage ($V_{CE} = V_{GE}$, $I_{C} = 1.0$ mA, $T_{j} = 25$ °C)	3.5	5.0	6.5) (- H -
V _{CE(ON)}	Collector-Emitter On Voltage (V_{GE} = 15V, I_{c} = 25A, T_{j} = 25°C)		2.5	3.2	Volts
	Collector-Emitter On Voltage (V_{GE} = 15V, I_{c} = 25A, T_{j} = 125°C)		3.3		
	Collector-Emitter On Voltage (V_{GE} = 15V, I_{c} = 50A, T_{j} = 25°C)		3.5		
I _{ces}	Collector Cut-off Current (V _{CE} = 1200V, V _{GE} = 0V, T _j = 25°C) ⁽²⁾		5	500	μA
020	Collector Cut-off Current (V _{CE} = 1200V, V _{GE} = 0V, T _j = 125°C) ⁽²⁾		50		
I _{GES}	Gate-Emitter Leakage Current (V _{GE} = ±20V)			±250	nA

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.





DYNAMIC CHARACTERISTICS

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
C _{ies}	Input Capacitance	Capacitance	İ	2784		
C _{oes}	Output Capacitance	$V_{GE} = 0V, V_{CE} = 25V$ f = 1MHz		271		рF
C _{res}	Reverse Transfer Capacitance			75		
V _{GEP}	Gate to Emitter Plateau Voltage		1	7.5		V
Q _g ③	Total Gate Charge	Gate Charge		154	203	
Q _{ge}	Gate-Emitter Charge	V _{GE} = 15V		20	27	0
Q _{gc}	Gate- Collector Charge	- V _{CE} = 600V - I _C = 25A		76	97	nC
t _{d(on)}	Turn-On Delay Time	Inductive Switching (25°C)	1	16		
t _r	Current Rise Time	V _{cc} = 600V		10		20
t _{d(off)}	Turn-Off Delay Time	V _{gE} = 15V		122		ns
t _r	Current Fall Time	l _c = 25A		20		
E _{on2} 5	Turn-On Switching Energy	$R_{G} = 4.3 \ \Omega^{(4)}$		742	1110	
E _{off}	Turn-Off Switching Energy	T _J = +25°C		427	640	μJ
t _{d(on)}	Turn-On Delay Time	Inductive Switching (125°C)		16		
t	Current Rise Time	V _{cc} = 600V		10		
t _{d(off)}	Turn-Off Delay Time	V _{GE} = 15V		136		ns
t _r	Current Fall Time	I _c = 25A		28		
E _{on2} 5	Turn-On Switching Energy	$R_{g} = 4.3 \ \Omega^{(4)}$		1297	1945	
E _{off}	Turn-Off Switching Energy	T_= +125°C		480	720	μJ

THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic	Min	Тур	Max	Unit
R _{ejc}	Junction to Case Thermal Resistance			.24	°C/W
R _{eja}	Junction to Ambient Thermal Resistance			40	
W _T	Package Weight		.22		oz
			6.2		g
Torque	Mounting Torque (TO-247 Package), 4-40 or M3 screw			10	in-lbf
				6.2	N∙m

1 Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.

2 Pulse test: Pulse Width < $380\mu s$, duty cycle < 2%.

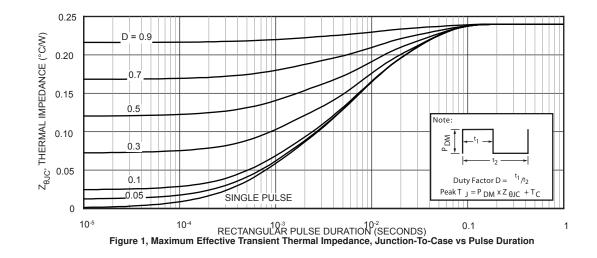
3 See Mil-Std-750 Method 3471.

4 R_G is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)

5 E_{on2} is the clamped inductive turn on energy that includes a commutating diode reverse recovery current in the IGBT turn on energy loss. A combi device is used for the clamping diode.

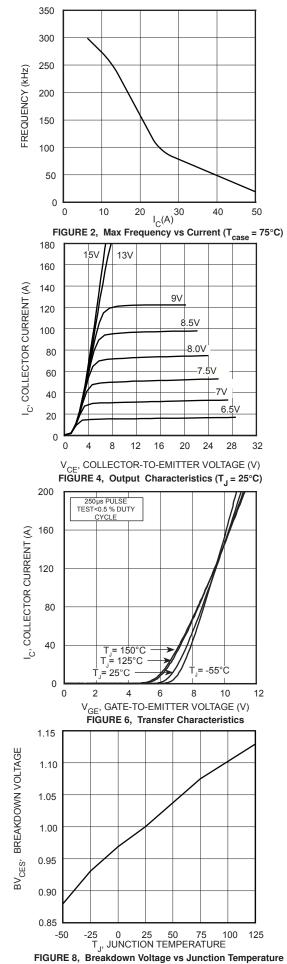
6 E_{off} is the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1.

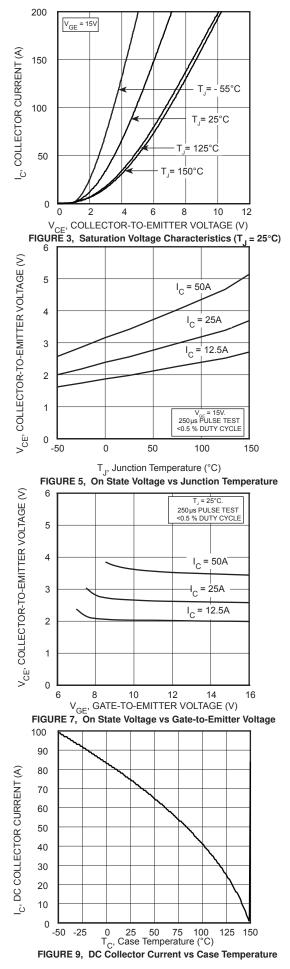
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TYPICAL PERFORMANCE CURVES

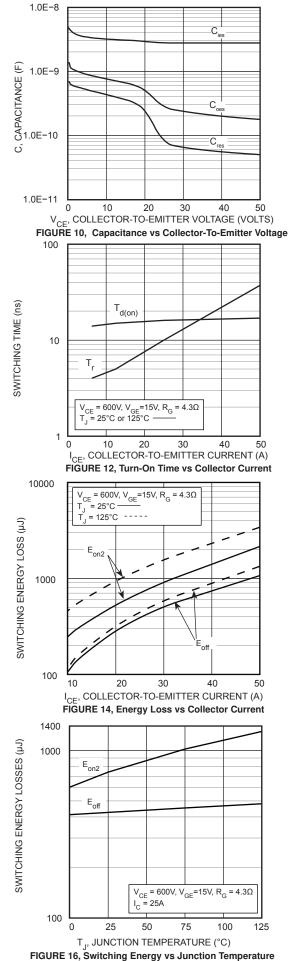
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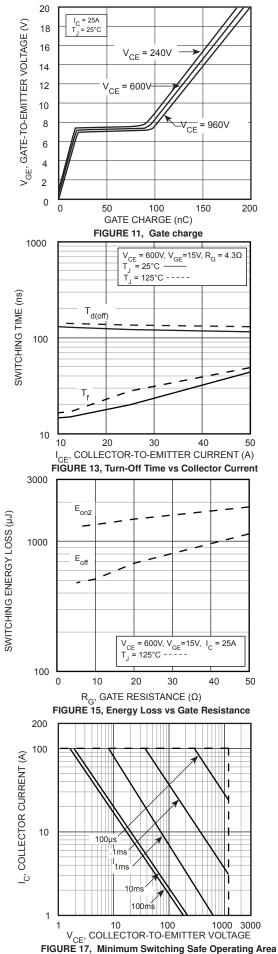






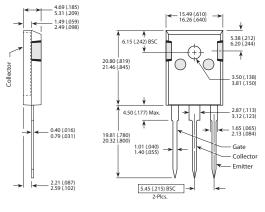








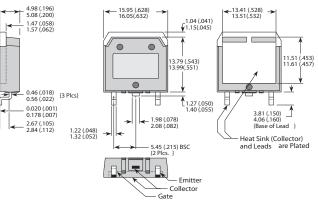
TO-247 Package Outline



Dimensions in Millimeters (Inches)



Collector (Heat Sink)



Dimensions in Millimeters (Inches)

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